

ZLLS410 10V Low leakage Schottky diode in SOD323

Summary

 $V_R > 10V$; $I_F = 570mA$; $I_R typ. 2\mu A$

Description

This compact SOD323 packaged 10 volt Schottky diode offers users an excellent performance combination, comprising high current operation, extremely low leakage and low forward voltage ensuring suitability for low voltage applications requiring efficient operation at higher temperatures above 85°C - see safe operating area charts on page 5.

Features

- · Extremely low leakage
- · High current capability
- · Low V_F, fast switching Schottky
- SOD323 package
- · Package thermally rated to 150°C

Applications

- · Low power DC-DC conversion
- · Level shifting
- · Reverse blocking

Ordering information

Device	Reel size (inches)	Tape width (mm)	Quantity per reel
ZLLS410TA	7	8	3000

Device marking

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Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Continuous reverse voltage	V_{R}	10	V
Forward current	I _F	570	mA
Peak repetitive forward current Rectangular pulse duty cycle 50%, Pulse width = 100µs	I _{FPK}	1.25	А
Non repetitive forward current $t \le 100 \mu s$ $t \le 10 ms$	I _{FSM}	17 4	Α
Power dissipation at T _{amb} = 25°C			
Continuous	P_{D}	330	mW
t ≤ 5 secs		390	mW
Operating and storage temperature range	T _j , T _{stg}	-55 to 150	°C

Thermal resistance

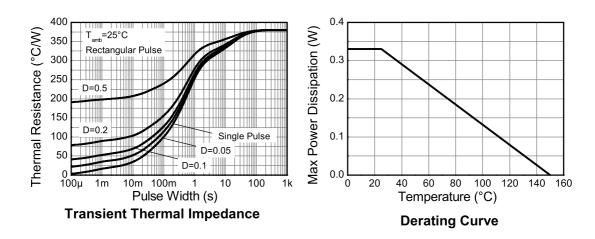
Parameter	Symbol	Limit	Unit
Junction to ambient ^(a)	R_{\ThetaJA}	379	°C/W
Junction to ambient ^(b)	$R_{\Theta JA}$	317	°C/W

NOTES:

⁽a) For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

⁽b) For a device surface mounted on FR4 PCB measured at t < 5 secs.

Thermal characteristics



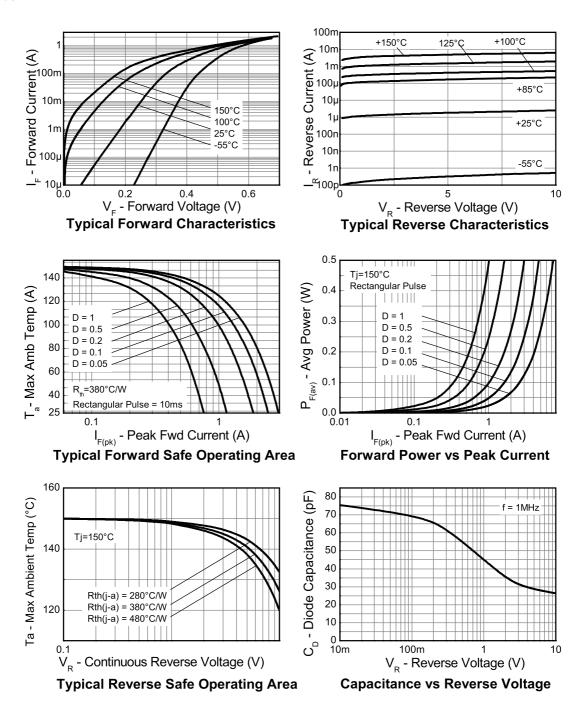
Electrical characteristics (at T_{amb} = 25°C unless otherwise stated)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Reverse breakdown voltage	BV _{(BR)R}	10			V	$I_R = 200 \mu A$
Forward voltage	V _F		250	290	mV	I _F = 10mA ^(*)
			330	380	mV	I _F = 100mA ^(*)
			535	580	mV	I _F = 1A ^(*)
Reverse current	I _R		1.8	4	μΑ	V _R = 5V
			2.2	5	μΑ	$V_R = 8V$
			2.5	6	μA	V _R = 10V
				300	μΑ	$V_R = 8V, T_A = 85^{\circ}C$
Diode capacitance	C _D		26		рF	f = 1MHz, V _R = 10V
Reverse recovery time	t _{rr}		3		ns	Switched from $I_F = 500$ mA to $V_R = 5.5$ V
Reverse recovery charge	Q _{rr}		210		рC	measured @ I_R 50mA di/dt = 500mA/ns R_{source} = $6\Omega < R_{load}$ = 10 Ω

NOTES:

^(*) Measured under pulsed conditions. Pulse width $\leq 300 \mu s$; duty cycle $\leq 2\%$.

Typical characteristics



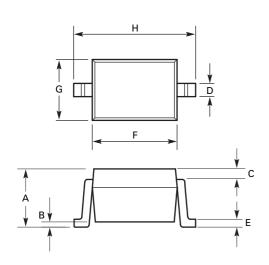
Note:

- 1. Both forward and reverse dissipation contributes to junction temperature rise. Forward and reverse junction temperature rise are determined and added together to give total junction temperature rise.
- 2. The safe operating curves are typical examples. Thermal resistance, pulse width and duty cycles are dependant on application.

ZLLS410

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Package outline - SOD323



Top mark



Cathode terminal is to RIGHT HAND side of part mark Part marking text displayed is for example only

Dim.	Millimeters		Dim.	Millimeters	
	Min.	Max.		Min.	Max.
А	0.91	1.16	Е	0.127	0.200
В	0.00	0.10	F	1.52	1.77
С	-	-	G	1.11	1.37
D	0.33	0.40	Н	2.46	2.71

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